



Features

Protects Two Line Pairs (Four Lines)

Low Operating and Clamping Voltages

listing can be found at

AEC-Q) for High Reliability.

products/.

Mechanical Data Package: SO-8

8

Low Capacitance < 3pF for High-Speed Interfaces

IEC 61000-4-5, Level 2 (Lightning), 24A (8/20µs)

IEC 61000-4-2, Level 4 (ESD), <= ±15kV (Air); <= ±8kV (Contact)

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

control (i.e.: parts gualified to AEC-Q100/101/104/200, PPAP

capable, and manufactured in IATF 16949 certified facilities),

please refer to the related automotive grade (Q-suffix) part. A

https://www.diodes.com/products/automotive/automotive-

This part is qualified to JEDEC standards (as references in

Package Material: Molded Plastic, "Green" Molding Compound.

Terminals: Matte Tin Finish Annealed over Copper Leadframe

(Lead Free Plating). Solderable per MIL-STD-202, Method 208 (e3)

https://www.diodes.com/guality/product-definitions/

UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020

Halogen and Antimony Free. "Green" Device (Note 3) For automotive applications requiring specific change

Product Summary

| VPT (Min) | PP (Max) | Ст (Тур) |
|-----------|----------|----------|
| 3.0V | 80A | 2.6pF |

Description

The DIODES™ D2V8F4U8MR of transient voltage suppressors are designed to protect low voltage. This has been specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from overvoltage caused by ESD (electrostatic discharge), CDE (cable discharge events), and FET (electrical fast transients).

SO-8

Top View

Applications

- 10/100/1000 Ethernet
- WAN/LAN equipment
- Switching systems
- Desktops, serves and notebooks
- Base stations

Weight: 0.08 grams (Approximate) Ο 3 4

Device Schematic

Ordering Information (Note 4)

| Part Number | Package | Marking Reel Size (inches) Tape Width (mm) | Marking Bool Size (inches) Tone Width (mr | icking | | |
|---------------|-----------------|--|---|--------|---------|-------------|
| Fait Nulliber | Package Marking | neel Size (Inches) | Tape width (mm) | Qty. | Carrier | |
| D2V8F4U8MR-13 | SO-8 | 2V8K8-4 | 13 | 12 | 2,500 | Tape & Reel |

Top View

Pin Configuration

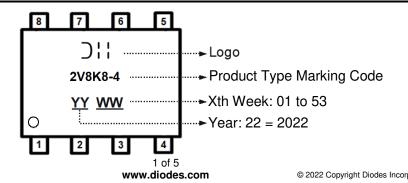
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | Conditions |
|------------------------------------|----------------------|-------|------|------------------------|
| Peak Pulse Power Dissipation | Ppp | 600 | W | 8/20μs, per Figure 1 |
| Peak Pulse Current | IPP | 80 | А | 8/20μs, per Figure 1 |
| ESD Protection – Contact Discharge | VESD_Contact | ±8 | kV | IEC 61000-4-2 Standard |
| ESD Protection – Air Discharge | V _{ESD_Air} | ±15 | kV | IEC 61000-4-2 Standard |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|--------|-------------|------|
| Package Power Dissipation (Note 5) | PD | 550 | mW |
| Thermal Resistance, Junction to Ambient (Note 5) | Reja | 54.26 | °C/W |
| Operating Temperature Range | TJ | -55 to +125 | °C |
| Storage Temperature Range | Tstg | -55 to +150 | °C |
| Soldering Temperature, t max = 10s | TL | +260 | °C |

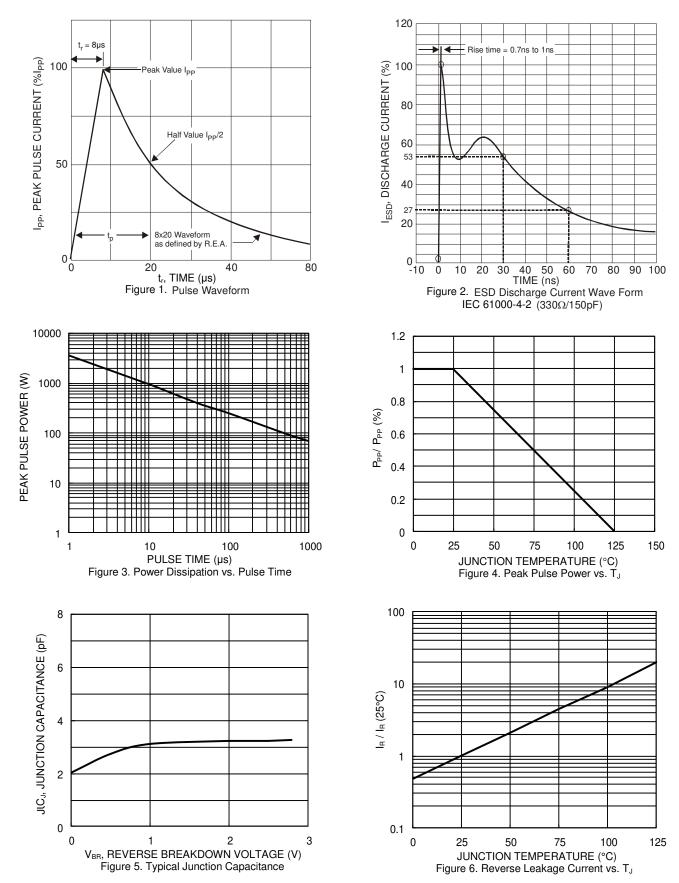
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---------------------------------------|--------|-----|-----|-----|------|--|
| Reverse Standoff Voltage | VRWM | _ | _ | 2.8 | V | — |
| Channel Leakage Current (Note 6) | IRM | _ | — | 1 | μΑ | V _{RWM} = 2.8V |
| Punch Through Voltage | VPT | 3 | _ | _ | V | Ipt = 2μA |
| Snap-Back Voltage | Vsb | 2.8 | — | _ | v | I _{SB} = 50mA |
| Clamping Voltage, Positive Transients | | | _ | 5 | v | IPP = 1A, tp = 8/20µs, Figure 1 |
| | Vcl | | _ | 15 | | IPP = 24A, tp = 8/20µs, Figure 1 |
| | | | — | 17 | | I _{PP} = 80A, tp = 8/20µs, Figure 1 |
| Channel Input Capacitance | CT | _ | 2.6 | 3 | pF | $V_R = 0V$, f = 1MHz, each line |

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

6. Short duration pulse test used to minimize self-heating effect.



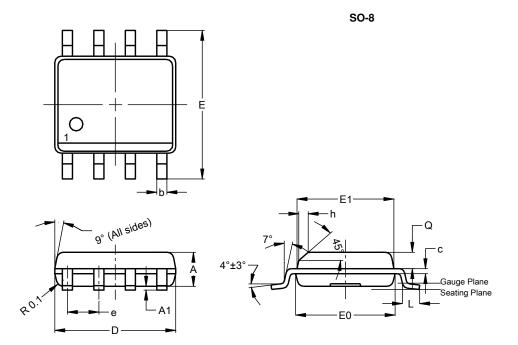


D2V8F4U8MR Document number: DS43661 Rev. 2 - 2



Package Outline Dimensions

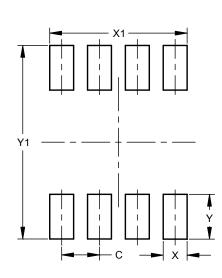
Please see http://www.diodes.com/package-outlines.html for the latest version.



| | SO-8 | | | | |
|----------------------|------|------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 1.40 | 1.50 | 1.45 | | |
| A1 | 0.10 | 0.20 | 0.15 | | |
| b | 0.30 | 0.50 | 0.40 | | |
| С | 0.15 | 0.25 | 0.20 | | |
| D | 4.85 | 4.95 | 4.90 | | |
| Е | 5.90 | 6.10 | 6.00 | | |
| E1 | 3.80 | 3.90 | 3.85 | | |
| E0 | 3.85 | 3.95 | 3.90 | | |
| е | | | 1.27 | | |
| h | - | | 0.35 | | |
| L | 0.62 | 0.82 | 0.72 | | |
| q | 0.60 | 0.70 | 0.65 | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 1.27 |
| Х | 0.802 |
| X1 | 4.612 |
| Y | 1.505 |
| Y1 | 6.50 |

D2V8F4U8MR Document number: DS43661 Rev. 2 - 2 SO-8



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